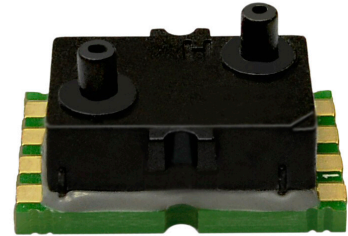


## LME series – digital low differential pressure sensors

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The LME differential low pressure sensors are based on thermal flow measurement of gas through a micro-flow channel integrated within the sensor chip. The innovative LME technology features superior sensitivity especially for ultra low pressures. The extremely low gas flow through the sensor ensures high immunity to dust contamination, humidity and long tubing compared to other flow-based pressure sensors.



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### Features

- Ultra-low pressure ranges from 25 to 2500 Pa (0.1 to 10 inH<sub>2</sub>O)
- Pressure sensor based on thermal micro-flow measurement
- High flow impedance
  - very low flow-through leakage
  - high immunity to dust and humidity
  - no loss in sensitivity using long tubing
- Outstanding long-term stability and precision with patented real-time offset compensation and linearization techniques
- Offset long term stability better than 0.1 Pa/year
- Total accuracy better than 0.5% FS typical
- On-chip temperature sensor
- Linearized digital SPI and analog outputs
- Small footprint, low profile, only 9 mm in height, and robust package
- Pressure ports for direct manifold assemblies
- Highly versatile to fit to application-specific mounting adapters and manifolds
- Minimized internal volume and manifold mount option allow for fast gas purge time
- No position sensitivity

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### Certificates

- Quality Management System according to EN ISO 13485 and EN ISO 9001
- RoHS and REACH compliant

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### Media compatibility

Air and other non-corrosive gases

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### Applications

#### Medical

- Ventilators
- Spirometers
- CPAP
- Sleep diagnostic equipment
- Nebulizers
- Oxygen conservers/concentrators
- Insufflators/endoscopy

#### Industrial

- HVAC
  - VAV
  - Filter monitoring
  - Burner control
- Fuel cells
- Gas leak detection
- Gas metering
- Fume hood
- Instrumentation
- Security systems

## LME series – digital low differential pressure sensors

### Maximum ratings

Parameter	Min.	Max.	Unit
Supply voltage $V_s$	4.75	5.25	$V_{DC}$
Output current		1	mA
Soldering recommendations			
Reflow soldering <sup>(1) (2)</sup>			
Average preheating temperature gradient		1.5	K/s
Time above 217 °C		74	s
Time above 240 °C		30	
Peak temperature		245	°C
Cooling temperature gradient		-1.4	K/s
Wave soldering, pot temperature		260	°C
Hand soldering, tip temperature		370	°C
Temperature ranges			
Compensated	0	+70	°C
Operating	-20	+80	°C
Storage	-40	+80	°C
Humidity limits (non-condensing)		97	%RH
Vibration <sup>(3)</sup>		20	g
Mechanical shock <sup>(4)</sup>		500	g

### Pressure sensor characteristics

Part no.	Operating pressure	Proof pressure <sup>(5)</sup>	Burst pressure <sup>(5)</sup>
LMES025U...	0...25 Pa / 0...0.25 mbar (0.1 inH <sub>2</sub> O)		
LMES050U...	0...50 Pa / 0...0.5 mbar (0.2 inH <sub>2</sub> O)		
LMES100U...	0...100 Pa / 0...1 mbar (0.4 inH <sub>2</sub> O)		
LMES250U...	0...250 Pa / 0...2.5 mbar (1 inH <sub>2</sub> O)		
LMES500U...	0...500 Pa / 0...5 mbar (2 inH <sub>2</sub> O)		
LMEM012U...	0...1250 Pa / 0...12.5 mbar (5 inH <sub>2</sub> O)		
LMEM025U...	0...2500 Pa / 0...25 mbar (10 inH <sub>2</sub> O)		
LMES025B...	0...±25 Pa / 0...±0.25 mbar (0.1 inH <sub>2</sub> O)	2 bar (30 psi)	5 bar (75 psi)
LMES050B...	0...±50 Pa / 0...±0.5 mbar (0.2 inH <sub>2</sub> O)		
LMES100B...	0...±100 Pa / 0...±1 mbar (0.4 inH <sub>2</sub> O)		
LMES250B...	0...±250 Pa / 0...±2.5 mbar (1 inH <sub>2</sub> O)		
LMES500B...	0...±500 Pa / 0...±5 mbar (2 inH <sub>2</sub> O)		
LMEM012B...	0...±1250 Pa / 0...±12.5 mbar (5 inH <sub>2</sub> O)		
LMEM025B...	0...±2500 Pa / 0...±25 mbar (10 inH <sub>2</sub> O)		

### Gas correction factors <sup>(6)</sup>

Gas type	Correction factor
Dry air	1.0
Oxygen (O <sub>2</sub> )	1.07
Nitrogen (N <sub>2</sub> )	0.97
Argon (Ar)	0.98
Carbon dioxide (CO <sub>2</sub> )	0.56

#### Specification notes

- (1) Recommendations only. Actually reflow settings depend on many factors, for example, number of oven heating and cooling zones, type of solder paste/flux used, board and component size, as well as component density. It is the responsibility of the customer to fine tune their processes for optimal results.
- (2) Handling instruction: Products are packaged in vacuum sealed moisture barrier bag with a floor life of 168hours (<30C, 60% R.H.). If floor life or environmental conditions have been exceeded prior to reflow assembly, baking is recommended. Recommended bake-out procedure is 72 hours @ 60C.
- (3) Sweep 20 to 2000 Hz, 8 min, 4 cycles per axis, MIL-STD-883, Method 2007.
- (4) 5 shocks, 3 axes, MIL-STD-883E, Method 2002.4.
- (5) The max. common mode pressure is 5 bar.
- (6) For example with a LMES500... sensor measuring CO<sub>2</sub> gas, at full-scale output the actual pressure will be:

$$\Delta P_{\text{eff}} = \Delta P_{\text{Sensor}} \times \text{gas correction factor} = 500 \text{ Pa} \times 0.56 = 280 \text{ Pa}$$

$$\Delta P_{\text{eff}} = \text{True differential pressure}$$

$$\Delta P_{\text{Sensor}} = \text{Differential pressure as indicated by output signal}$$

## LME series – digital low differential pressure sensors

### Performance characteristics <sup>(7)</sup>

( $V_S=5.0 V_{DC}$ ,  $T_A=20\text{ °C}$ ,  $P_{Abs}=1\text{ bara}$ , calibrated in air, output signal is non-ratiometric to  $V_S$ )

#### 25 Pa and 50 Pa devices

Parameter	Min.	Typ.	Max.	Unit
Noise level (RMS)		±0.01		Pa
Offset warm-up shift			less than noise	
Offset long term stability <sup>(8)</sup>		±0.05	±0.1	Pa/year
Offset repeatability		±0.01		Pa
Span repeatability <sup>(11, 12)</sup>		±0.25		% of reading
Current consumption (no load) <sup>(9)</sup>		7	8	mA
Response time ( $t_{63}$ )		5		ms
Power-on time			25	ms

#### Digital output

Parameter	Min.	Typ.	Max.	Unit	
Scale factor (digital output) <sup>(10)</sup>	0...25/0...±25 Pa	1200		counts/Pa	
	0...50/0...±50 Pa	600		counts/Pa	
Zero pressure offset accuracy <sup>(11)</sup>		±0.1	±0.2	%FSS	
Span accuracy <sup>(11, 12)</sup>		±0.4	±0.75	% of reading	
Thermal effects	Offset	5...55 °C		±0.2	%FSS
		0...70 °C		±0.4	%FSS
	Span	5...55 °C	±1	±1.75	% of reading
		0...70 °C	±2	±2.75	% of reading

#### Analog output (unidirectional devices)

Parameter	Min.	Typ.	Max.	Unit	
Zero pressure offset <sup>(11)</sup>	0.49	0.50	0.51	V	
Full scale output		4.50		V	
Span accuracy <sup>(11, 12)</sup>		±0.4	±0.75	% of reading	
Thermal effects	Offset	5...55 °C		±15	mV
		0...70 °C		±30	mV
	Span	5...55 °C	±1.25	±2	% of reading
		0...70 °C	±2	±2.75	% of reading

#### Analog output (bidirectional devices)

Parameter	Min.	Typ.	Max.	Unit	
Zero pressure offset <sup>(11)</sup>	2.49	2.50	2.51	V	
Output	at max. specified pressure	4.50		V	
	at min. specified pressure	0.50		V	
Span accuracy <sup>(11, 12)</sup>		±0.4	±0.75	% of reading	
Thermal effects	Offset	5...55 °C		±15	mV
		0...70 °C		±30	mV
	Span	5...55 °C	±1.25	±2	% of reading
		0...70 °C	±2	±2.75	% of reading

#### Specification notes (cont.)

(7) The sensor is calibrated with a common mode pressure of 1 bar absolute. Due to the mass flow based measuring principle, variations in absolute common mode pressure need to be compensated according to the following formula:

$$\Delta P_{\text{eff}} = \Delta P_{\text{Sensor}} \times 1 \text{ bara} / P_{\text{abs}}$$

$\Delta P_{\text{eff}}$  = True differential pressure

$\Delta P_{\text{Sensor}}$  = Differential pressure as indicated by output voltage

$P_{\text{abs}}$  = Current absolute common mode pressure

(8) Figure based on accelerated lifetime test of 10000 hours at 85 °C biased burn-in.

(9) Please contact First Sensor for low power options.

(10) The digital output signal is a signed, two complement integer. Negative pressures will result in a negative output

(11) Zero pressure offset accuracy and span accuracy are uncorrelated uncertainties. They can be added according to the principles of error propagation.

(12) Span accuracy below 10% of full scale is limited by the intrinsic noise of the sensor.

## LME series – digital low differential pressure sensors

### Performance characteristics (cont.) <sup>(7)</sup>

(V<sub>S</sub>=5.0 V<sub>DC</sub>, T<sub>A</sub>=20 °C, P<sub>Abs</sub>=1 bara, calibrated in air, output signal is non-ratiometric to V<sub>S</sub>)

#### 100 Pa, 250 Pa and 500 Pa devices

Parameter	Min.	Typ.	Max.	Unit
Noise level (RMS)		±0.01		%FSS
Offset warm-up shift			less than noise	
Offset long term stability <sup>(8)</sup>		±0.05	±0.1	%FSS/year
Offset repeatability <sup>(13)</sup>		±0.02		Pa
Span repeatability <sup>(11, 12)</sup>		±0.25		% of reading
Current consumption (no load) <sup>(9)</sup>		7	8	mA
Response time (t <sub>63</sub> )		5		ms
Power-on time			25	ms

#### Digital output

Parameter	Min.	Typ.	Max.	Unit	
Scale factor (digital output) <sup>(10)</sup>	0...100/0...±100 Pa	300		counts/Pa	
	0...250/0...±250 Pa	120		counts/Pa	
	0...500/0...±500 Pa	60		counts/Pa	
Zero pressure offset accuracy <sup>(11)</sup>		±0.05	±0.1	%FSS	
Span accuracy <sup>(11, 12)</sup>		±0.4	±0.75	% of reading	
Thermal effects	Offset	5...55 °C		±0.1	%FSS
		0...70 °C		±0.2	%FSS
	Span	5...55 °C	±1	±1.75	% of reading
		0...70 °C	±2	±2.75	% of reading

#### Analog output (unidirectional devices)

Parameter	Min.	Typ.	Max.	Unit	
Zero pressure offset <sup>(11)</sup>	0.49	0.50	0.51	V	
Full scale output		4.50		V	
Span accuracy <sup>(11, 12)</sup>		±0.4	±0.75	% of reading	
Thermal effects	Offset	5...55 °C		±10	mV
		0...70 °C		±12	mV
	Span	5...55 °C	±1	±1.75	% of reading
		0...70 °C	±2	±2.75	% of reading

#### Analog output (bidirectional devices)

Parameter	Min.	Typ.	Max.	Unit	
Zero pressure offset <sup>(11)</sup>	2.49	2.50	2.51	V	
Output	at max. specified pressure	4.50		V	
	at min. specified pressure	0.50		V	
Span accuracy <sup>(11, 12)</sup>		±0.4	±0.75	% of reading	
Thermal effects	Offset	5...55 °C		±10	mV
		0...70 °C		±12	mV
	Span	5...55 °C	±1	±1.75	% of reading
		0...70 °C	±2	±2.75	% of reading

#### Specification notes (cont.)

(7) The sensor is calibrated with a common mode pressure of 1 bar absolute. Due to the mass flow based measuring principle, variations in absolute common mode pressure need to be compensated according to the following formula:

$$\Delta P_{\text{eff}} = \Delta P_{\text{Sensor}} \times 1 \text{ bara} / P_{\text{abs}}$$

$\Delta P_{\text{eff}}$  = True differential pressure

$\Delta P_{\text{Sensor}}$  = Differential pressure as indicated by output voltage

$P_{\text{abs}}$  = Current absolute common mode pressure

(8) Figure based on accelerated lifetime test of 10000 hours at 85 °C biased burn-in.

(9) Please contact First Sensor for low power options.

(10) The digital output signal is a signed, two complement integer. Negative pressures will result in a negative output

(11) Zero pressure offset accuracy and span accuracy are uncorrelated uncertainties. They can be added according to the principles of error propagation.

(12) Span accuracy below 10% of full scale is limited by the intrinsic noise of the sensor.

(13) Typical value for 250 Pa sensors.

## LME series – digital low differential pressure sensors

### Performance characteristics (cont.) <sup>(7, 14)</sup>

( $V_S=5.0 V_{DC}$ ,  $T_A=20\text{ °C}$ ,  $P_{Abs}=1\text{ bara}$ , calibrated in air, output signal is non-ratiometric to  $V_S$ )

#### 1250 Pa and 2500 Pa devices

Parameter	Min.	Typ.	Max.	Unit
Noise level (RMS)		±0.5		Pa
Offset warm-up shift			less than noise	
Offset long term stability <sup>(8)</sup>		±1.25	±2.5	Pa/year
Offset repeatability		±0.5		Pa
Span repeatability <sup>(11, 12)</sup>		±0.25		% of reading
Current consumption (no load) <sup>(9)</sup>		7	8	mA
Response time ( $t_{63}$ )		5		ms
Power-on time			25	ms

#### Digital output

Parameter	Min.	Typ.	Max.	Unit	
Scale factor (digital output) <sup>(10)</sup>	0...1250/0...±1250 Pa	24		counts/Pa	
	0...2500/0...±2500 Pa	12		counts/Pa	
Zero pressure offset accuracy <sup>(11)</sup>		±0.1	±0.2	%FSS	
Span accuracy <sup>(11, 12)</sup>		±0.75	±1.5	% of reading	
Thermal effects	Offset	5...55 °C		±0.1	%FSS
		0...70 °C		±0.2	%FSS
	Span	5...55 °C	±1	±1.75	% of reading
		0...70 °C	±2	±2.75	% of reading

#### Analog output (unidirectional devices)

Parameter	Min.	Typ.	Max.	Unit	
Zero pressure offset <sup>(11)</sup>	0.49	0.50	0.51	V	
Full scale output		4.50		V	
Span accuracy <sup>(11, 12)</sup>		±0.75	±1.5	% of reading	
Thermal effects	Offset	5...55 °C		±10	mV
		0...70 °C		±12	mV
	Span	5...55 °C	±1.25	±2	% of reading
		0...70 °C	±2	±2.75	% of reading

#### Analog output (bidirectional devices)

Parameter	Min.	Typ.	Max.	Unit	
Zero pressure offset <sup>(11)</sup>	2.49	2.50	2.51	V	
Output	at max. specified pressure	4.50		V	
	at min. specified pressure	0.50		V	
Span accuracy <sup>(11, 12)</sup>		±0.75	±1.5	% of reading	
Thermal effects	Offset	5...55 °C		±10	mV
		0...70 °C		±12	mV
	Span	5...55 °C	±1.25	±2	% of reading
		0...70 °C	±2	±2.75	% of reading

#### Specification notes (cont.)

(7) The sensor is calibrated with a common mode pressure of 1 bar absolute. Due to the mass flow based measuring principle, variations in absolute common mode pressure need to be compensated according to the following formula:

$$\Delta P_{\text{eff}} = \Delta P_{\text{Sensor}} \times 1 \text{ bara} / P_{\text{abs}}$$

$\Delta P_{\text{eff}}$  = True differential pressure

$\Delta P_{\text{Sensor}}$  = Differential pressure as indicated by output voltage

$P_{\text{abs}}$  = Current absolute common mode pressure

(8) Figure based on accelerated lifetime test of 10000 hours at 85 °C biased burn-in.

(9) Please contact First Sensor for low power options.

(10) The digital output signal is a signed, two complement integer. Negative pressures will result in a negative output

(11) Zero pressure offset accuracy and span accuracy are uncorrelated uncertainties. They can be added according to the principles of error propagation.

(12) Span accuracy below 10% of full scale is limited by the intrinsic noise of the sensor.

(14) For pressure ranges 1250 Pa and 2500 Pa, more accurate absolute pressure correction procedures than in (5) might be needed. See Application Note "Absolute pressure correction of LME/LMI pressure sensors".

## LME series – digital low differential pressure sensors

### Performance characteristics (cont.)

Temperature sensor				
Parameter	Min.	Typ.	Max.	Unit
Scale factor (digital output)		95		counts/°C
Non-linearity		±0.5		%FS
Hysteresis		±0.1		% FS

#### Total accuracy <sup>(15)</sup>

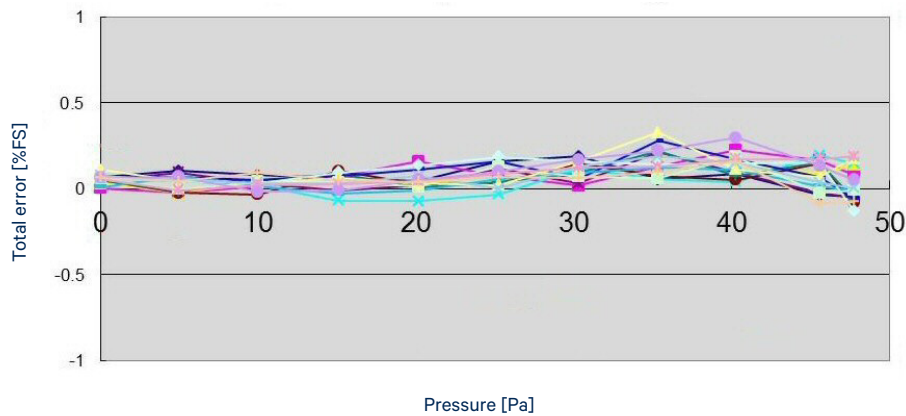


Fig. 1: Typical total accuracy plot of 16 LME 50 Pa sensors @ 25 °C (typical total accuracy better than 0.5 %FS)

#### Offset long term stability

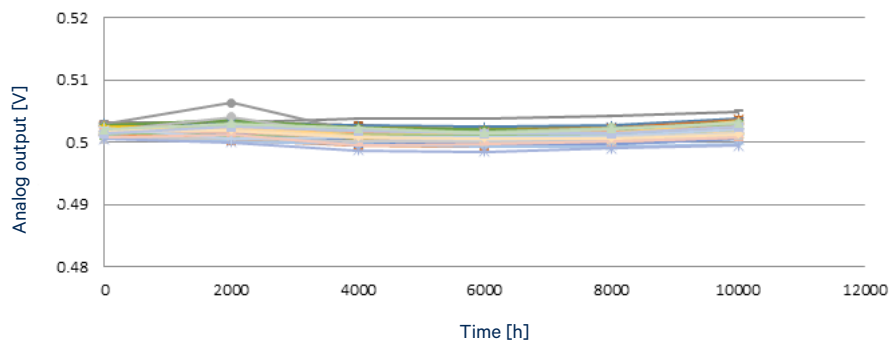


Fig. 2: Offset long term stability for LME 250 Pa sensors after 10,000 hours @ 85°C powered, equivalent to over 43.5 years @ 25 °C (better than ±2 mV / ±0.125 Pa)

#### Specification notes (cont.)

(15) Total accuracy is the combined error from offset and span calibration, non-linearity, repeatability and pressure hysteresis

## LME series – digital low differential pressure sensors

### SPI – Serial Peripheral Interface

#### Introduction

The LME serial interface is a high-speed synchronous data input and output communication port. The serial interface operates using a standard 4-wire SPI bus. The LME device runs in SPI mode 0, which requires the clock line SCLK to idle low (CPOL = 0), and for data to be sampled on the leading clock edge (CPHA = 0). Figure 5 illustrates this mode of operation.

Care should be taken to ensure that the sensor is properly connected to the master microcontroller. Refer to the manufacturer's datasheet for more information regarding physical connections.

#### Application circuit

The use of pull-up resistors is generally unnecessary for SPI as most master devices are configured for push-pull mode. There are, however, some cases where it may be helpful to use 33Ω series resistors at both ends of the SPI lines, as shown in Figure 3.

Signal quality may be further improved by the addition of a buffer as shown in Figure 4. These cases include multiple slave devices on the same bus segment, using a master device with limited driving capability and long SPI bus lines.

If these series resistors are used, they must be physically placed as close as possible to the pins of the master and slave devices.

#### Signal control

The serial interface is enabled by asserting /CS low. The serial input clock, SCLK, is gated internally to begin accepting the input data at MOSI, or sending the output data on MISO. When /CS rises, the data clocked into MOSI is loaded into an internal register.

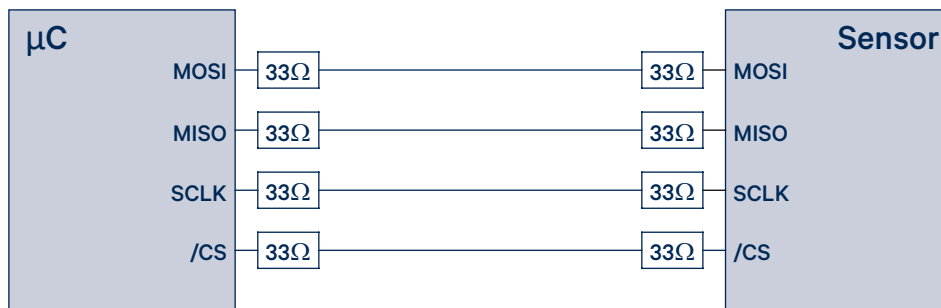


Fig. 3: Application circuit with resistors at both ends of the SPI lines

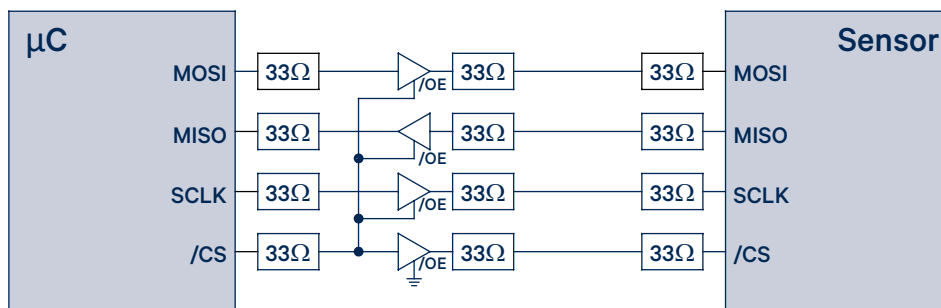


Fig. 4: Application circuit with additional buffer

## LME series – digital low differential pressure sensors

### SPI – Serial Peripheral Interface (cont.)

#### Data read – pressure

When powered on, the sensor begins to continuously measure pressure. To initiate data transfer from the sensor, the following three unique bytes must be written sequentially, MSB first, to the MOSI pin (see Figure 5):

Step	Hexadecimal	Binary	Description
1	0x2D	B00101101	Poll current pressure measurement
2	0x14	B00010100	Send result to data register
3	0x98	B10011000	Read data register

The entire 16 bit content of the LME register is then read out on the MISO pin, MSB first, by applying 16 successive clock pulses to SCLK with /CS asserted low. Note that the value of the LSB is held at zero for internal signal processing purposes. This is below the noise threshold of the sensor and thus its fixed value does not affect sensor performance and accuracy.

From the digital sensor output the actual pressure value can be calculated as follows:

$$\text{Pressure [Pa]} = \frac{\text{Digital output [counts]}}{\text{Scale factor} \left[ \frac{\text{counts}}{\text{Pa}} \right]}$$

For example, for a ±250 Pa sensor (LMES250B...) with a scale factor of 120 a digital output of 30 000 counts (7530'h) calculates to a positive pressure of 250 Pa. Similarly, a digital output of -30 000 counts (8AD0'h) calculates to a negative pressure of -250 Pa.

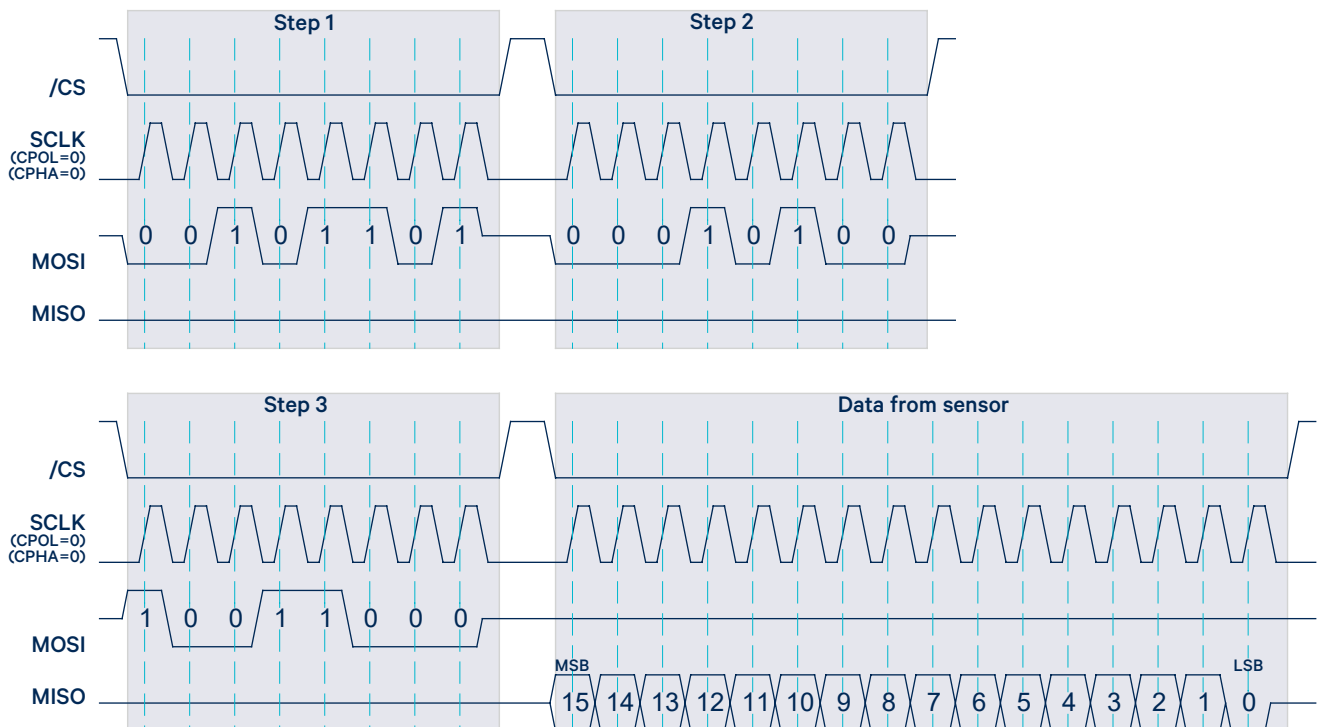


Fig. 5: SPI data transfer



## LME series – digital low differential pressure sensors

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### SPI – Serial Peripheral Interface (cont.)

#### Data read – temperature

The on-chip temperature sensor changes 95 counts/°C over the operating range. The temperature data format is 15-bit plus sign in two's complement format. To read temperature, use the following sequence:

Step	Hexadecimal	Binary	Description
1	0x2A	B00101010	Poll current temperature measurement
2	0x14	B00010100	Send result to data register
3	0x98	B10011000	Read data register

From the digital sensor output, the actual temperature can be calculated as follows:

$$\text{Temperature [}^{\circ}\text{C]} = \frac{\text{TS} - \text{TS}_0 \text{ [counts]}}{\text{Scale factor}_{\text{TS}} \left[ \frac{\text{counts}}{^{\circ}\text{C}} \right]} + T_0 \text{ [}^{\circ}\text{C]}$$

where

TS is the actual sensor readout;

TS<sub>0</sub> is the sensor readout at known temperature T<sub>0</sub><sup>(16)</sup>;

Scale factor<sub>TS</sub> = 95 counts/°C

#### Specification notes (cont.)

(16) To be defined by user. The results show deviation (in °C) from the offset calibrated temperature.

## LME series – digital low differential pressure sensors

### SPI – Serial Peripheral Interface (cont.)

#### Interface specification

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
			Min.	Max.		
External clock frequency	$f_{ECLK}$	$V_{CKSEL}=0$		0.2		MHz
External master clock input low time	$f_{ECLKIN LO}$	$t_{ECLK}=1/f_{ECLK}$	40		60	% $t_{ECLK}$
External master clock input high time	$f_{ECLKIN HI}$	$t_{ECLK}=1/f_{ECLK}$	40		60	% $t_{ECLK}$
SCLK setup to falling edge /CS	$t_{SC}$		30			ns
/CS falling edge to SCLK rising edge setup time	$t_{CSS}$		30			ns
/CS idle time	$t_{CSI}$	$f_{CLK}=4\text{ MHz}$	1.5			$\mu\text{s}$
SCLK falling edge to data valid delay	$t_{DO}$	$C_{LOAD}=15\text{ pF}$			80	
Data valid to SCLK rising edge setup time	$t_{DS}$		30			
Data valid to SCLK rising edge hold time	$t_{DH}$		30			
SCLK high pulse width	$t_{CH}$		100			ns
SCLK low pulse width	$t_{CL}$		100			ns
/CS rising edge to SCLK rising edge hold time	$t_{CSH}$		30			
/CS falling edge to output enable	$t_{DV}$	$C_{LOAD}=15\text{ pF}$			25	
/CS rising edge to output disable	$t_{TR}$	$C_{LOAD}=15\text{ pF}$			25	
Maximum output load capacitance	$C_{LOAD}$	$R_{LOAD}=\infty$ , phase margin $>55^\circ$		200		pF
Input voltage, logic HIGH	$V_{IH}$		$0.8 \times V_S$		$V_S + 0.3$	
Input voltage, logic LOW	$V_{IL}$				$0.2 \times V_S$	
Output voltage, logic HIGH	$V_{OH}$	$R_{LOAD}=\infty$	$V_S - 0.1$			V
Output voltage, logic LOW	$V_{OL}$	$R_{LOAD}=2\text{ k}\Omega$	$V_S - 0.15$			
		$R_{LOAD}=\infty$			0.5	
		$R_{LOAD}=2\text{ k}\Omega$			0.2	

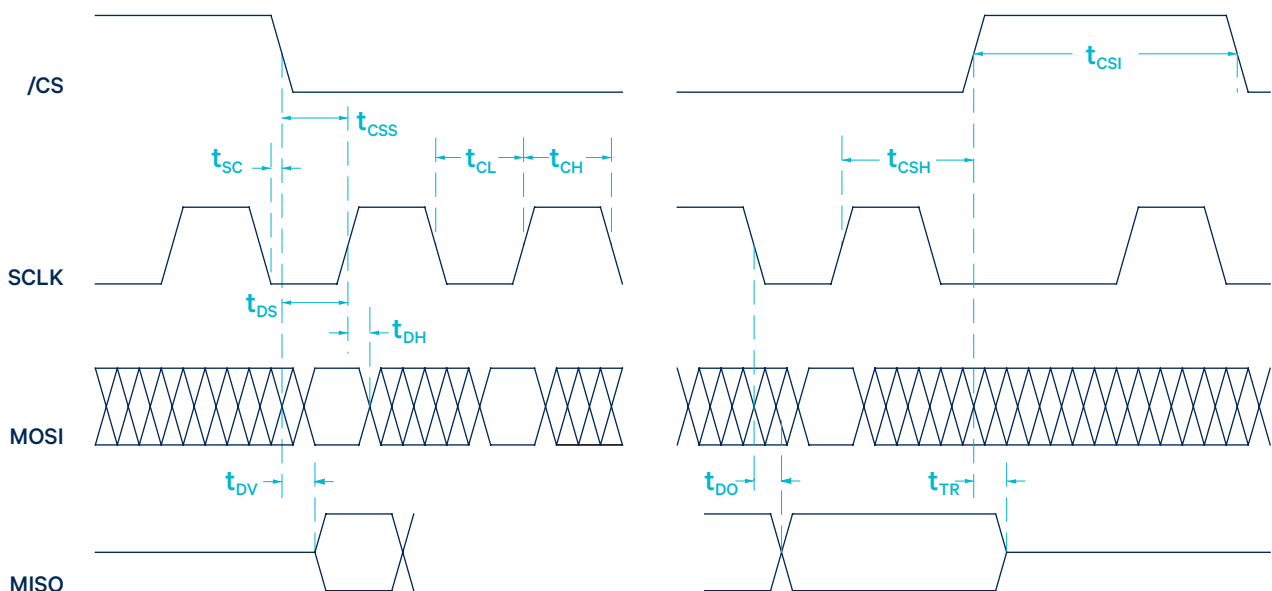
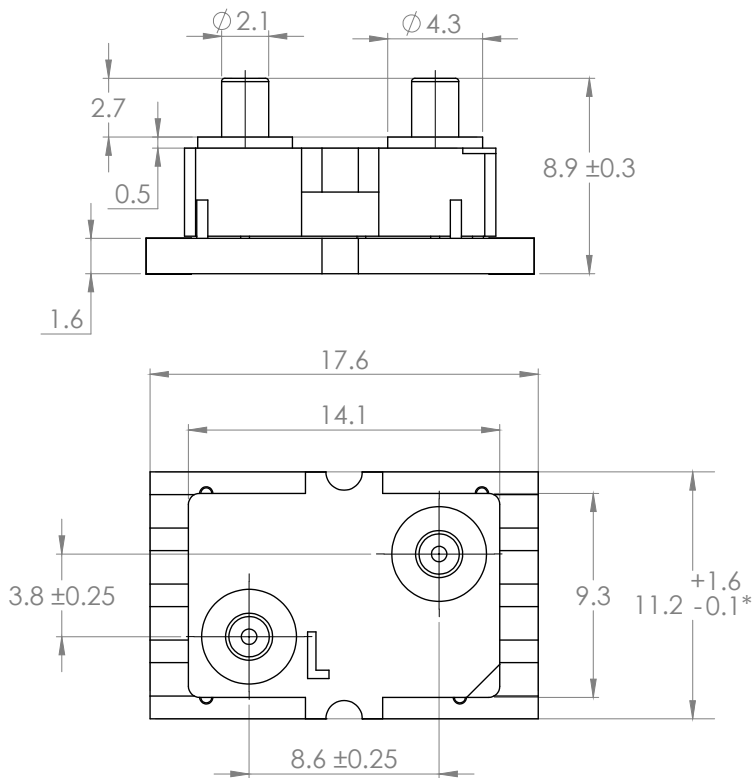


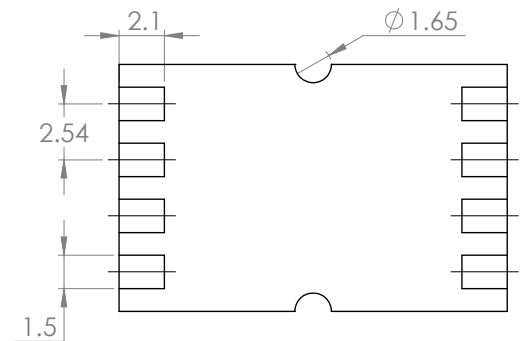
Fig. 6: SPI timing diagram

## LME series – digital low differential pressure sensors

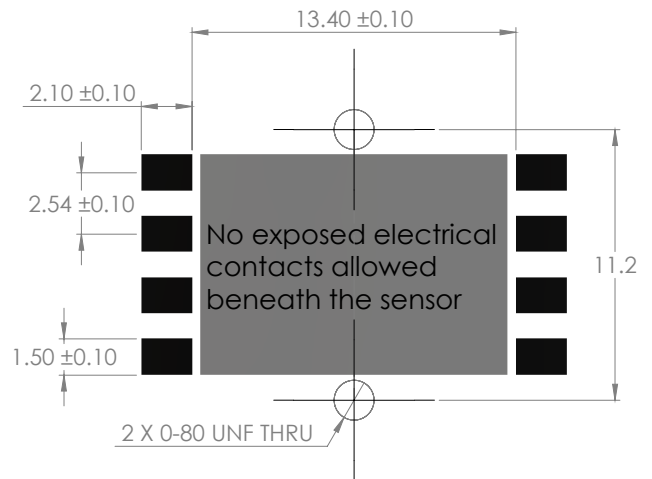
### Dimensional drawing



dimensions in mm  
 dimensions without tolerance are for reference only  
 \*large PCB tolerance due to thin burs left after V-cut



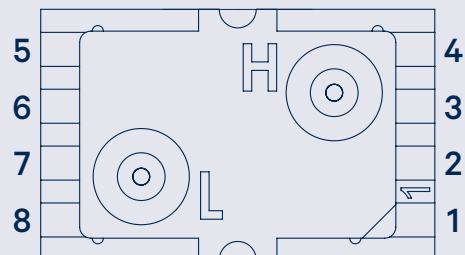
### Suggested PCB land pattern



### Electrical connection

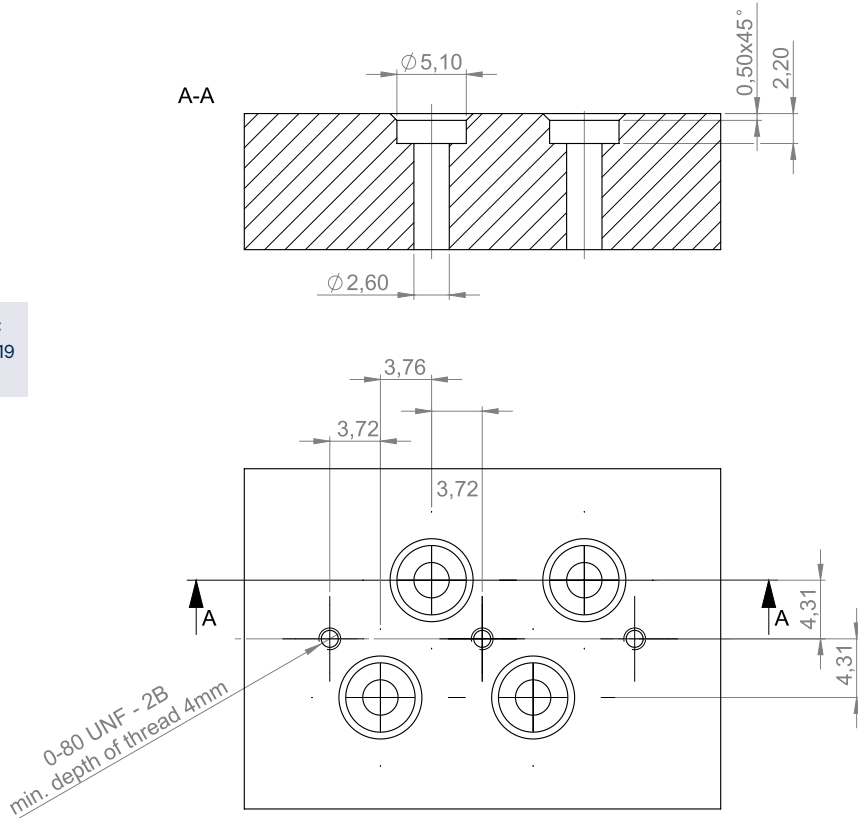
There are two use cases that will change the manner in which the LME series device is connected in-circuit:

Pin	Function	Case 1: Digital signal output	Case 2: Analog signal output
1	$V_s$	+5V	+5V
2	GND	GND	GND
3	Vout	NC	High impedance analog input (e.g. op-amp, ADC)
4	Reserved	NC	NC
5	SCLK	Master device SCLK	GND
6	MOSI	Master device MOSI	GND
7	MISO	Master device MISO	GND
8	/CS	Master device (/CS)	$V_s$

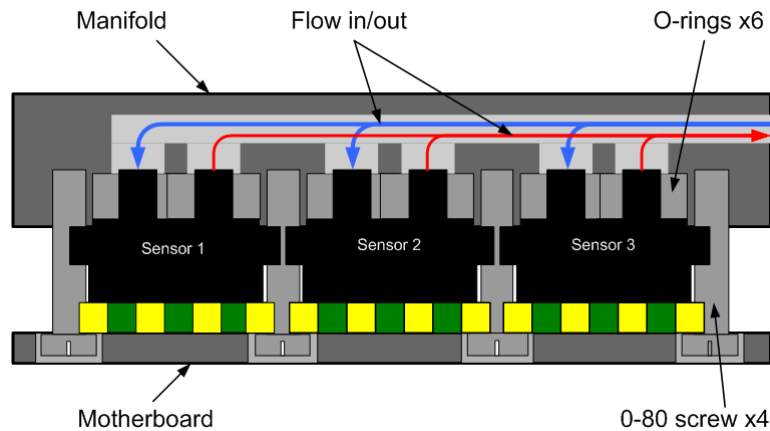


## LME series – digital low differential pressure sensors

### Recommended manifold dimensions for two side-by-side mounted sensors



### Recommended manifold schematic for multiple side-by-side mounted sensors

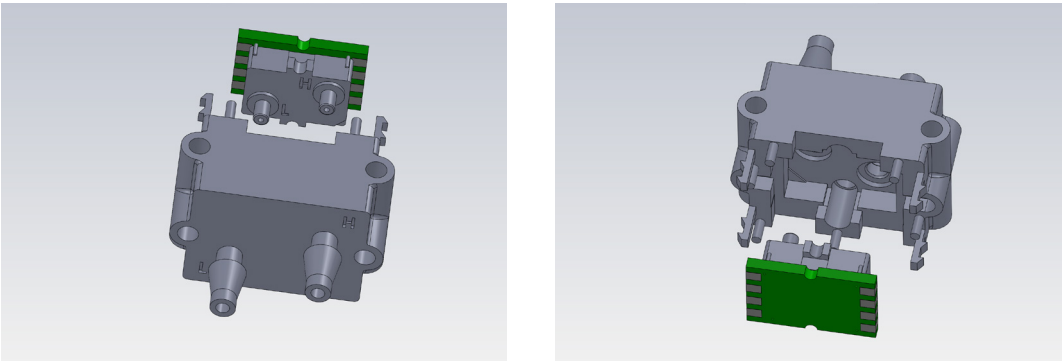


## LME series – digital low differential pressure sensors

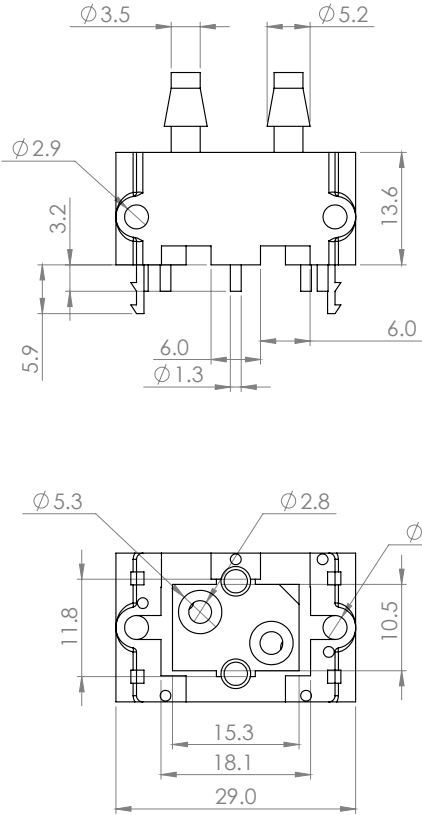
### Custom adapter

The LME series pressure sensors can optionally be equipped with a custom adapter for your application-specific mounting requirements. It is designed for applications where wider port spacing and diameter are needed. Please contact First Sensor for more information.

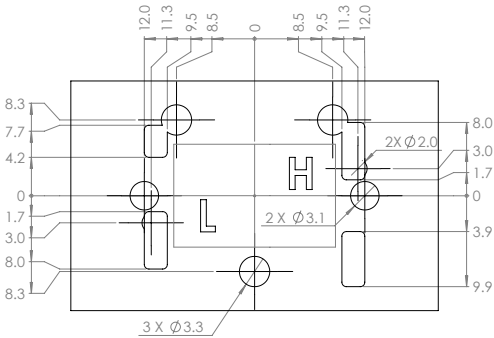
#### 3D views of a custom adapter for the LME pressure sensor



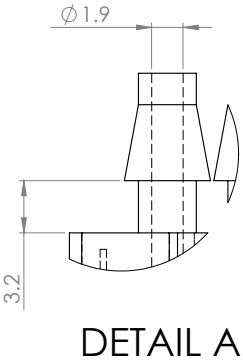
#### Dimensional drawing ZA009102 plug-in adapter



#### Example of PCB layout for plug-in adapter



Hole pattern is provided with reference dimensions only. Please ensure that the final design allows for positioning errors of the PCB assembly process.



dimensions in mm